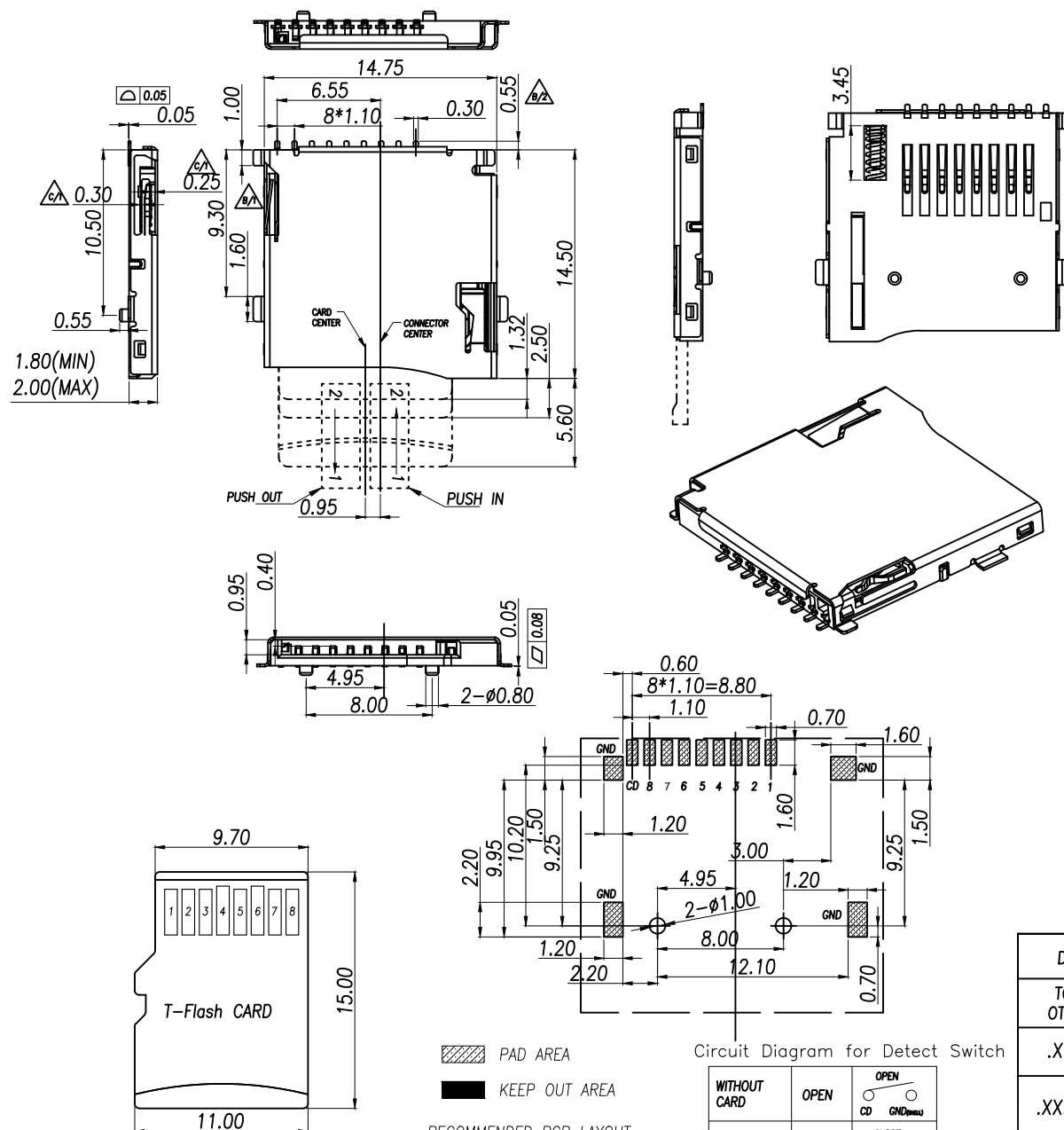


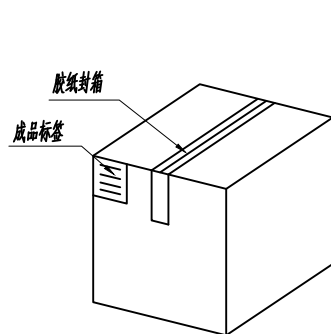
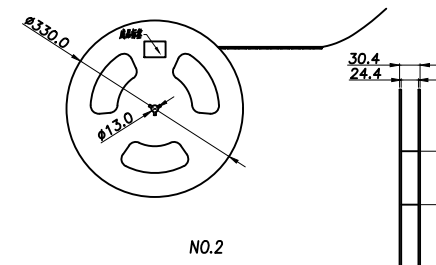
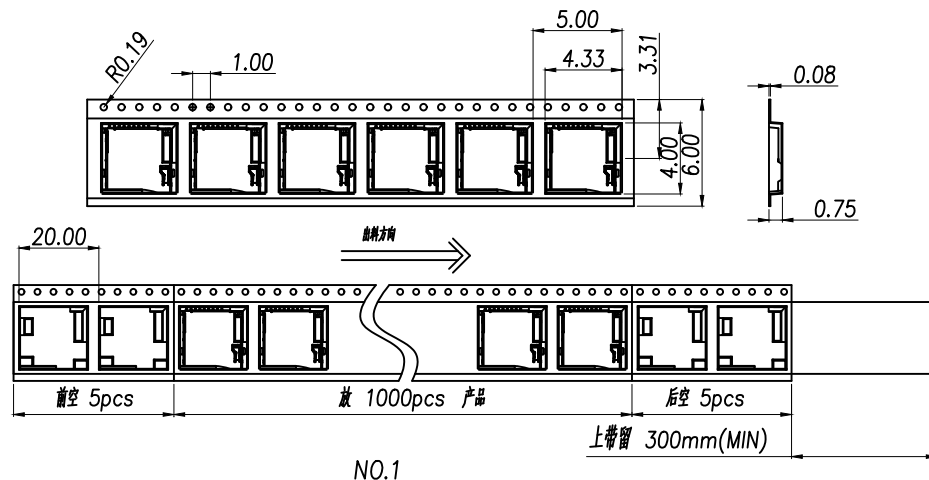


Specification:

1. Electrical Characteristics:
 - Contact Current Rating: 0.5 Amperes.
 - Dielectric Withstanding Voltage: AC500V r.m.s.
 - Insulation Resistance: 1000 MΩ Minimum.
 - Contact Resistance: 40 mΩ Maximum.
2. Environmental:
 - Operating Temperature: -25°C ~ +90°C.
3. Environmental:
 - Mating Cycles: 5,000 Insertions.
4. Mechanical Characteristics:
 - Card Push Insertion/Out Force: 0.2 ~ 1.40 kgf.
 - Contact Separation Force: 0.20 kgf Minimum.
5. Material:
 - Insulator: HI-Temp Plastic UL 94V-0 Rated.
 - Contact: Copper Alloy (t=0.15mm).
 - Shell: Stainless Steel (t=0.15mm).
 - Spring: SWP.

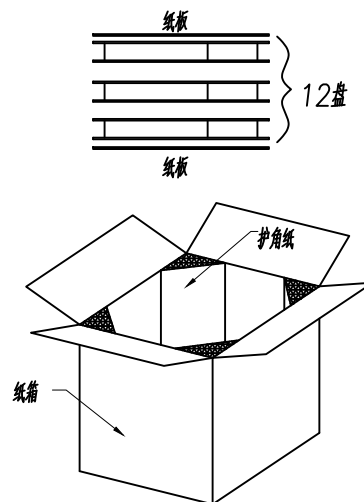
PIN NO.	NAME	YTPЕ	DESCRIPTION
1	DAT2	I/O/PP	DATE LINE(BIT2)
2	CD/DAT3	I/O/PP	CARD DETECT DATE LIN(BIT3)
3	CMD	PP	COMMAND RESPONSE
4	VDD	S	SUPPLY VOLTAGE
5	CLX	I	CLOCK
6	VSS	S	SUPPLY VOLTAGE GROUND
7	DAT0	I/O/PP	DATE LINE(BIT0)
8	DAT1	I/O/PP	DATE LINE(DIT1)

DIMENSION IN mm		厦门市辛译精密电子有限公司 Xiamen XinYi Xyeconn Electronics Co.,Ltd				
TOLERANCE UNLESS OTHERWISE SPECIFIED						
.X±0.35	X.*±3	APR. Alex	TITLE: MICRO SD CARD PUSH PUSH SMT 整精			
.XX±0.25	.X*±2	CHK. Jack	DWG NO. XY-TF-15			
.XXX±0.15	.XX*±	DRA. Can	PROJ. 		CUSTOMER DRAWING	
			SIZE A4	SCALE 1:1	SHEET 1 / 1	REV. A



纸箱规格:340*340*385

NO.4



NO.3

1. 材质要求:

- 1.1 纸箱的材质为K=K;外形尺寸为34*34*38.5;
- 1.2 卷盘的材质为PS,卷盘的外形尺寸为 $\phi 330 \times 30.4$;
- 1.3 卷带的材质为PS,卷带的外形尺寸为20200*24.00*3.0mm;

2. 包装方式:

- 2.1 将卷带放入包装机后,前空5PCS,后放产品1000PCS,再后空5PCS;上带留300MM长度。
- 2.2 将包装好的产品从包装机上取下并包装好,贴上内盘标签;
- 2.3 把累叠好的12盘叠放入纸箱中共计12Kset,上下放纸板,纸箱四个角塞护角纸;
- 2.4 把包装好的成品打包封箱,并在纸箱外贴上标签

DIMENSION IN mm		厦门市辛译精密电子有限公司 Xiamen XinYi Xyeconn Electronics Co.,Ltd			
TOLERANCE UNLESS OTHERWISE SPECIFIED					
.X±	X.*±	APR. Alex	TITLE: MICRO SD CARD PUSH PUSH SMT 鑫译		
.XX±	.X*±	CHK. Jack	DWG NO. XY-TF-15		
.XXX±	.XX*±	DRA. Can	PROJ. 		CUSTOMER DRAWING
			SIZE A4	SCALE 1:1	SHEET REV. A